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Intel - 10AS027H2F35I2LG Datasheet



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Embedded - System On Chip (SoC): The Heart of Modern Embedded Systems

Embedded - System On Chip (SoC) refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

What are **Embedded - System On Chip (SoC)**?

System On Chip (SoC) integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions. SoCs combine a central

Details

| Product Status | Active |
|-------------------------|--|
| Architecture | MCU, FPGA |
| Core Processor | Dual ARM® Cortex®-A9 MPCore [™] with CoreSight [™] |
| Flash Size | - |
| RAM Size | 256KB |
| Peripherals | DMA, POR, WDT |
| Connectivity | EBI/EMI, Ethernet, I ² C, MMC/SD/SDIO, SPI, UART/USART, USB OTG |
| Speed | 1.5GHz |
| Primary Attributes | FPGA - 270K Logic Elements |
| Operating Temperature | -40°C ~ 100°C (TJ) |
| Package / Case | 1152-BBGA, FCBGA |
| Supplier Device Package | 1152-FBGA, FC (35x35) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/10as027h2f35i2lg |
| | |

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Intel[®] Arria[®] 10 Device Overview

The Intel[®] Arria[®] 10 device family consists of high-performance and power-efficient 20 nm mid-range FPGAs and SoCs.

Intel Arria 10 device family delivers:

- Higher performance than the previous generation of mid-range and high-end FPGAs.
- Power efficiency attained through a comprehensive set of power-saving technologies.

The Intel Arria 10 devices are ideal for high performance, power-sensitive, midrange applications in diverse markets.

| Market | Applications |
|-----------------------|---|
| Wireless | Channel and switch cards in remote radio headsMobile backhaul |
| Wireline | 40G/100G muxponders and transponders 100G line cards Bridging Aggregation |
| Broadcast | Studio switches Servers and transport Videoconferencing Professional audio and video |
| Computing and Storage | Flash cacheCloud computing serversServer acceleration |
| Medical | Diagnostic scannersDiagnostic imaging |
| Military | Missile guidance and control Radar Electronic warfare Secure communications |

Table 1. Sample Markets and Ideal Applications for Intel Arria 10 Devices

Related Information

Intel Arria 10 Device Handbook: Known Issues Lists the planned updates to the *Intel Arria 10 Device Handbook* chapters.

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Key Advantages of Intel Arria 10 Devices

Table 2. Key Advantages of the Intel Arria 10 Device Family

| Advantage | Supporting Feature |
|---|--|
| Enhanced core architecture | Built on TSMC's 20 nm process technology 60% higher performance than the previous generation of mid-range FPGAs 15% higher performance than the fastest previous-generation FPGA |
| High-bandwidth integrated transceivers | Short-reach rates up to 25.8 Gigabits per second (Gbps) Backplane capability up to 12.5 Gbps Integrated 10GBASE-KR and 40GBASE-KR4 Forward Error Correction (FEC) |
| Improved logic integration and hard IP blocks | 8-input adaptive logic module (ALM) Up to 65.6 megabits (Mb) of embedded memory Variable-precision digital signal processing (DSP) blocks Fractional synthesis phase-locked loops (PLLs) Hard PCI Express Gen3 IP blocks Hard memory controllers and PHY up to 2,400 Megabits per second (Mbps) |
| Second generation hard processor system (HPS) with integrated ARM* Cortex*-A9* MPCore* processor | Tight integration of a dual-core ARM Cortex-A9 MPCore processor, hard IP, and an FPGA in a single Intel Arria 10 system-on-a-chip (SoC) Supports over 128 Gbps peak bandwidth with integrated data coherency between the processor and the FPGA fabric |
| Advanced power savings | Comprehensive set of advanced power saving features Power-optimized MultiTrack routing and core architecture Up to 40% lower power compared to previous generation of mid-range FPGAs Up to 60% lower power compared to previous generation of high-end FPGAs |

Summary of Intel Arria 10 Features

Table 3. Summary of Features for Intel Arria 10 Devices

| Feature | Description |
|---------------------------------|--|
| Technology | TSMC's 20-nm SoC process technology Allows operation at a lower V_{CC} level of 0.82 V instead of the 0.9 V standard V_{CC} core voltage |
| Packaging | 1.0 mm ball-pitch Fineline BGA packaging 0.8 mm ball-pitch Ultra Fineline BGA packaging Multiple devices with identical package footprints for seamless migration between different FPGA densities Devices with compatible package footprints allow migration to next generation high-end Stratix[®] 10 devices RoHS, leaded⁽¹⁾, and lead-free (Pb-free) options |
| High-performance FPGA fabric | Enhanced 8-input ALM with four registers Improved multi-track routing architecture to reduce congestion and improve compilation time Hierarchical core clocking architecture Fine-grained partial reconfiguration |
| Internal memory blocks | M20K—20-Kb memory blocks with hard error correction code (ECC) Memory logic array block (MLAB)—640-bit memory |
| | continued |

⁽¹⁾ Contact Intel for availability.



| Feature | Description | | | | | | | |
|--------------------------------------|--|--|--|--|--|--|--|--|
| Embedded Hard IP blocks | Variable-precision DSP | Native support for signal processing precision levels from 18 x 19 to 54 x 54 Native support for 27 x 27 multiplier mode 64-bit accumulator and cascade for systolic finite impulse responses (FIRs) Internal coefficient memory banks Preadder/subtractor for improved efficiency Additional pipeline register to increase performance and reduce power Supports floating point arithmetic: Perform multiplication, addition, subtraction, multiply-add, multiply-subtract, and complex multiplication. Supports multiplication with accumulation capability, cascade summation, and cascade subtraction capability. Dynamic accumulator reset control. Support direct vector dot and complex multiplication chaining multiply floating point DSP blocks. | | | | | | |
| | Memory controller | DDR4, DDR3, and DDR3L | | | | | | |
| | PCI Express* | PCI Express (PCIe*) Gen3 (x1, x2, x4, or x8), Gen2 (x1, x2, x4, or x8) and Gen1 (x1, x2, x4, or x8) hard IP with complete protocol stack, endpoint, and root port | | | | | | |
| | Transceiver I/O | 10GBASE-KR/40GBASE-KR4 Forward Error Correction (FEC) PCS hard IPs that support: 10-Gbps Ethernet (10GbE) PCIe PIPE interface Interlaken Gbps Ethernet (GbE) Common Public Radio Interface (CPRI) with deterministic latency support Gigabit-capable passive optical network (GPON) with fast lock-time support 13.5G JESD204b 8B/10B, 64B/66B, 64B/67B encoders and decoders Custom mode support for proprietary protocols | | | | | | |
| Core clock networks | 667 MHz externa 800 MHz LVDS in Global, regional, and | c clocking, depending on the application: I memory interface clocking with 2,400 Mbps DDR4 interface terface clocking with 1,600 Mbps LVDS interface I peripheral clock networks are not used can be gated to reduce dynamic power | | | | | | |
| Phase-locked loops (PLLs) | Support integer r Fractional mode s Integer PLLs: Adjacent to gene | nthesis, clock delay compensation, and zero delay buffering (ZDB) node and fractional mode support with third-order delta-sigma modulation | | | | | | |
| FPGA General-purpose I/Os (GPIOs) | On-chip termination | ry pair can be configured as receiver or transmitter (OCT) -ended LVTTL/LVCMOS interfacing | | | | | | |
| External Memory Interface | Hard memory controller— DDR4, DDR3, and DDR3L support DDR4—speeds up to 1,200 MHz/2,400 Mbps DDR3—speeds up to 1,067 MHz/2,133 Mbps Soft memory controller—provides support for RLDRAM 3⁽²⁾, QDR IV⁽²⁾, and QDR II+ | | | | | | | |



| Feature | Description | | | | | | |
|--|--|---------|--|--|--|--|--|
| Low-power serial transceivers | Continuous operating range: Intel Arria 10 GX—1 Gbps to 17.4 Gbps Intel Arria 10 GT—1 Gbps to 25.8 Gbps Backplane support: Intel Arria 10 GT—up to 12.5 Intel Arria 10 GT—up to 12.5 Extended range down to 125 Mbps with oversampling ATX transmit PLLs with user-configurable fractional synthesis capability Electronic Dispersion Compensation (EDC) support for XFP, SFP+, QSFP, and CFP optical module Adaptive linear and decision feedback equalization Transmitter pre-emphasis and de-emphasis Dynamic partial reconfiguration of individual transceiver channels | | | | | | |
| HPS (Intel Arria 10 SX devices only) | Processor and system • Dual-core ARM Cortex-A9 MPCore processor—1.2 GHz CPU with 1.5 GHz overdrive capability • 256 KB on-chip RAM and 64 KB on-chip ROM • System peripherals—general-purpose timers, watchdog timers, di memory access (DMA) controller, FPGA configuration manager, ar clock and reset managers • Security features—anti-tamper, secure boot, Advanced Encryptior Standard (AES) and authentication (SHA) • ARM CoreSight* JTAG debug access port, trace port, and on-chip trace storage | nd n | | | | | |
| | External interfaces Hard memory interface—Hard memory controller (2,400 Mbps DE and 2,133 Mbps DDR3), Quad serial peripheral interface (QSPI) fl controller, NAND flash controller, direct memory access (DMA) controller, Secure Digital/MultiMediaCard (SD/MMC) controller Communication interface—10/100/1000 Ethernet media access control (MAC), USB On-The-GO (OTG) controllers, I²C controllers, UART 16550, serial peripheral interface (SPI), and up to 62 HPS GPIO interfaces (48 direct-share I/Os) | lash | | | | | |
| | Interconnects to core • High-performance ARM AMBA* AXI bus bridges that support simultaneous read and write • HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to iss transactions to slaves in the HPS, and vice versa • Configuration bridge that allows HPS configuration manager to configure the core logic via dedicated 32-bit configuration port • FPGA-to-HPS SDRAM controller bridge—provides configuration interfaces for the multiport front end (MPFE) of the HPS SDRAM controller | | | | | | |
| Configuration | Tamper protection—comprehensive design protection to protect your valuable IP investment Enhanced 256-bit advanced encryption standard (AES) design security with authentication Configuration via protocol (CvP) using PCIe Gen1, Gen2, or Gen3 | | | | | | |
| | continue | d | | | | | |

 $^{^{(2)}\,}$ Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.



| Feature | Description |
|--------------------|---|
| | Dynamic reconfiguration of the transceivers and PLLs Fine-grained partial reconfiguration of the core fabric Active Serial x4 Interface |
| Power management | SmartVID Low static power device options Programmable Power Technology Intel Quartus Prime integrated power analysis |
| Software and tools | Intel Quartus Prime design suite Transceiver toolkit Platform Designer system integration tool DSP Builder for Intel FPGAs OpenCL[™] support Intel SoC FPGA Embedded Design Suite (EDS) |

Related Information

Intel Arria 10 Transceiver PHY Overview Provides details on Intel Arria 10 transceivers.

Intel Arria 10 Device Variants and Packages

Table 4. Device Variants for the Intel Arria 10 Device Family

| Variant | Description |
|-------------------|---|
| Intel Arria 10 GX | FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. |
| Intel Arria 10 GT | FPGA featuring: 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. 25.8 Gbps transceivers for supporting CAUI-4 and CEI-25G applications with CFP2 and CFP4 modules. |
| Intel Arria 10 SX | SoC integrating ARM-based HPS and FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. |

Intel Arria 10 GX

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

Related Information

Intel FPGA Product Selector

Provides the latest information on Intel products.



Maximum Resources

Table 10. Maximum Resource Counts for Intel Arria 10 GT Devices

| Reso | urce | Produ | ct Line |
|------------------------------|----------------------|-----------|-------------------|
| | | GT 900 | GT 1150 |
| Logic Elements (LE) (K) | | 900 | 1,150 |
| ALM | | 339,620 | 427,200 |
| Register | | 1,358,480 | 1,708,800 |
| Memory (Kb) | M20K | 48,460 | 54,260 |
| | MLAB | 9,386 | 12,984 |
| Variable-precision DSP Block | | 1,518 | 1,518 |
| 18 x 19 Multiplier | | 3,036 | 3,036 |
| PLL | Fractional Synthesis | 32 | 32 |
| | I/O | 16 | 16 |
| Transceiver | 17.4 Gbps | 72 (5) | 72 ⁽⁵⁾ |
| | 25.8 Gbps | 6 | 6 |
| GPIO ⁽⁶⁾ | | 624 | 624 |
| LVDS Pair ⁽⁷⁾ | | 312 | 312 |
| PCIe Hard IP Block | | 4 | 4 |
| Hard Memory Controller | | 16 | 16 |

Related Information

Intel Arria 10 GT Channel Usage

Configuring GT/GX channels in Intel Arria 10 GT devices.

Package Plan

Table 11.Package Plan for Intel Arria 10 GT Devices

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | SF45 (45 mm × 45 mm, 1932-pin FBGA) | | | | | |
|--------------|--|----------|------|--|--|--|
| | 3 V I/O | LVDS I/O | XCVR | | | |
| GT 900 | — | 624 | 72 | | | |
| GT 1150 | _ | 624 | 72 | | | |

⁽⁵⁾ If all 6 GT channels are in use, 12 of the GX channels are not usable.

⁽⁶⁾ The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

⁽⁷⁾ Each LVDS I/O pair can be used as differential input or output.



Related Information

I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.

Intel Arria 10 SX

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 SX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

Related Information

Intel FPGA Product Selector

Provides the latest information on Intel products.

Available Options

Figure 3. Sample Ordering Code and Available Options for Intel Arria 10 SX Devices



Related Information

Transceiver Performance for Intel Arria 10 GX/SX Devices Provides more information about the transceiver speed grade.



Maximum Resources

Table 12. Maximum Resource Counts for Intel Arria 10 SX Devices

| Resource | | Product Line | | | | | | | | |
|------------------------------|-------------------------|--------------|---------|---------|---------|----------|---------|-----------|--|--|
| | | SX 160 | SX 220 | SX 270 | SX 320 | SX 480 | SX 570 | SX 660 | | |
| Logic Elements | s (LE) (K) | 160 | 220 | 270 | 320 | 480 | 570 | 660 | | |
| ALM | | 61,510 | 80,330 | 101,620 | 119,900 | 183,590 | 217,080 | 251,680 | | |
| Register | | 246,040 | 321,320 | 406,480 | 479,600 | 734,360 | 868,320 | 1,006,720 | | |
| Memory (Kb) | M20K | 8,800 | 11,740 | 15,000 | 17,820 | 28,620 | 36,000 | 42,620 | | |
| | MLAB | 1,050 | 1,690 | 2,452 | 2,727 | 4,164 | 5,096 | 5,788 | | |
| Variable-precision DSP Block | | 156 | 192 | 830 | 985 | 1,368 1, | | 1,687 | | |
| 18 x 19 Multiplier | | 312 | 384 | 1,660 | 1,970 | 2,736 | 3,046 | 3,374 | | |
| PLL | Fractional Synthesis | 6 | 6 | 8 | 8 | 12 | 16 | 16 | | |
| | I/O | 6 | 6 | 8 | 8 | 12 | 16 | 16 | | |
| 17.4 Gbps Tra | nsceiver | 12 | 12 | 24 | 24 | 36 | 48 | 48 | | |
| GPIO ⁽⁸⁾ | | 288 | 288 | 384 | 384 | 492 | 696 | 696 | | |
| LVDS Pair ⁽⁹⁾ | | 120 | 120 | 168 | 168 | 174 | 324 | 324 | | |
| PCIe Hard IP Block | | 1 | 1 | 2 | 2 | 2 | 2 | 2 | | |
| Hard Memory Controller | | 6 | 6 | 8 | 8 | 12 | 16 | 16 | | |
| ARM Cortex-As Processor | M Cortex-A9 MPCore | | Yes | Yes | Yes | Yes | Yes | Yes | | |

Package Plan

Table 13.Package Plan for Intel Arria 10 SX Devices (U19, F27, F29, and F34)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | U19 (19 mm × 19 mm, 484-pin UBGA) | | F27 (27 mm × 27 mm, 672-pin FBGA) | | F29 (29 mm × 29 mm, 780-pin FBGA) | | | F34 (35 mm × 35 mm, 1152-pin FBGA) | | | | |
|--------------|---|-------------|---|------------|---|------|------------|--|------|------------|-------------|------|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR |
| SX 160 | 48 | 144 | 6 | 48 | 192 | 12 | 48 | 240 | 12 | _ | - | - |
| SX 220 | 48 | 144 | 6 | 48 | 192 | 12 | 48 | 240 | 12 | _ | - | - |
| SX 270 | - | - | _ | 48 | 192 | 12 | 48 | 312 | 12 | 48 | 336 | 24 |
| SX 320 | - | - | _ | 48 | 192 | 12 | 48 | 312 | 12 | 48 | 336 | 24 |
| continued | | | | | | | | | | | | |

⁽⁸⁾ The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

⁽⁹⁾ Each LVDS I/O pair can be used as differential input or output.



| Product Line | U19 (19 mm × 19 mm, 484-pin UBGA) | | F27 (27 mm × 27 mm, 672-pin FBGA) | | F29 (29 mm × 29 mm, 780-pin FBGA) | | F34 (35 mm × 35 mm, 1152-pin FBGA) | | | | | |
|--------------|---|-------------|---|------------|---|------|--|-------------|------|------------|-------------|------|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR |
| SX 480 | - | - | - | _ | - | - | 48 | 312 | 12 | 48 | 444 | 24 |
| SX 570 | - | - | _ | _ | - | - | _ | _ | - | 48 | 444 | 24 |
| SX 660 | - | - | - | - | - | - | _ | - | - | 48 | 444 | 24 |

Table 14. Package Plan for Intel Arria 10 SX Devices (F35, KF40, and NF40)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | F35 (35 mm × 35 mm, 1152-pin FBGA) | | | | KF40 (40 mm × 40 mm, 1517-pin FBGA) | | | NF40 (40 mm × 40 mm, 1517-pin FBGA) | | |
|--------------|--|----------|------|---------|---|------|---------|---|------|--|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | |
| SX 270 | 48 | 336 | 24 | - | _ | _ | - | - | _ | |
| SX 320 | 48 | 336 | 24 | - | _ | _ | _ | _ | _ | |
| SX 480 | 48 | 348 | 36 | - | _ | _ | - | - | _ | |
| SX 570 | 48 | 348 | 36 | 96 | 600 | 36 | 48 | 540 | 48 | |
| SX 660 | 48 | 348 | 36 | 96 | 600 | 36 | 48 | 540 | 48 | |

Related Information

I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.



I/O Vertical Migration for Intel Arria 10 Devices

Figure 4. Migration Capability Across Intel Arria 10 Product Lines

- The arrows indicate the migration paths. The devices included in each vertical migration path are shaded. Devices with fewer resources in the same path have lighter shades.
- To achieve the full I/O migration across product lines in the same migration path, restrict I/Os and transceivers usage to match the product line with the lowest I/O and transceiver counts.
- An LVDS I/O bank in the source device may be mapped to a 3 V I/O bank in the target device. To use
 memory interface clock frequency higher than 533 MHz, assign external memory interface pins only to
 banks that are LVDS I/O in both devices.
- There may be nominal 0.15 mm package height difference between some product lines in the same package type.
 - Package Product Variant Line U19 F27 KF40 NF40 RF40 NF45 SF45 UF45 F29 F34 F35 GX 160 GX 220 GX 270 GX 320 Intel® Arria® 10 GX GX 480 GX 570 GX 660 GX 900 GX 1150 GT 900 Intel Arria 10 GT GT 1150 SX 160 SX 220 SX 270 Intel Arria 10 SX SX 320 SX 480 SX 570 SX 660
- Some migration paths are not shown in the Intel Quartus Prime software Pin Migration View.

Note: To verify the pin migration compatibility, use the **Pin Migration View** window in the Intel Quartus Prime software Pin Planner.

Adaptive Logic Module

Intel Arria 10 devices use a 20 nm ALM as the basic building block of the logic fabric.

The ALM architecture is the same as the previous generation FPGAs, allowing for efficient implementation of logic functions and easy conversion of IP between the device generations.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than the traditional two-register per LUT architecture.



| Variant | Product Line | Variable- precision | Independent In Multiplicatio | put and Output ns Operator | 18 x 19 Multiplier | 18 x 18 Multiplier |
|---------|--------------|------------------------|---------------------------------|-------------------------------|-----------------------|--------------------------------------|
| | | DSP Block | 18 x 19 Multiplier | 27 x 27 Multiplier | Adder Sum Mode | Adder Summed with 36 bit Input |
| | SX 320 | 984 | 1,968 | 984 | 984 | 984 |
| | SX 480 | 1,368 | 2,736 | 1,368 | 1,368 | 1,368 |
| | SX 570 | 1,523 | 3,046 | 1,523 | 1,523 | 1,523 |
| | SX 660 | 1,687 | 3,374 | 1,687 | 1,687 | 1,687 |

Table 17. Resources for Floating-Point Arithmetic in Intel Arria 10 Devices

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

| Variant | Product Line | Variable- precision DSP Block | Single Precision Floating-Point Multiplication Mode | Single-Precision Floating-Point Adder Mode | Single- Precision Floating-Point Multiply Accumulate Mode | Peak Giga Floating- Point Operations per Second (GFLOPs) |
|----------------------|--------------|-------------------------------------|---|--|--|---|
| Intel Arria 10 GX | GX 160 | 156 | 156 | 156 | 156 | 140 |
| GA | GX 220 | 192 | 192 | 192 | 192 | 173 |
| | GX 270 | 830 | 830 | 830 | 830 | 747 |
| | GX 320 | 984 | 984 | 984 | 984 | 886 |
| | GX 480 | 1,369 | 1,368 | 1,368 | 1,368 | 1,231 |
| | GX 570 | 1,523 | 1,523 | 1,523 | 1,523 | 1,371 |
| | GX 660 | 1,687 | 1,687 | 1,687 | 1,687 | 1,518 |
| | GX 900 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| | GX 1150 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| Intel Arria 10 | GT 900 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| GT | GT 1150 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| Intel Arria 10 | SX 160 | 156 | 156 | 156 | 156 | 140 |
| SX | SX 220 | 192 | 192 | 192 | 192 | 173 |
| | SX 270 | 830 | 830 | 830 | 830 | 747 |
| | SX 320 | 984 | 984 | 984 | 984 | 886 |
| | SX 480 | 1,369 | 1,368 | 1,368 | 1,368 | 1,231 |
| | SX 570 | 1,523 | 1,523 | 1,523 | 1,523 | 1,371 |
| | SX 660 | 1,687 | 1,687 | 1,687 | 1,687 | 1,518 |

Embedded Memory Blocks

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.



Types of Embedded Memory

The Intel Arria 10 devices contain two types of memory blocks:

- 20 Kb M20K blocks—blocks of dedicated memory resources. The M20K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide and shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Intel Arria 10 devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB.

Embedded Memory Capacity in Intel Arria 10 Devices

| | Product | M2 | :0K | ML | AB | Total RAM Bit |
|-------------------|---------|-------|--------------|--------|--------------|---------------|
| Variant | Line | Block | RAM Bit (Kb) | Block | RAM Bit (Kb) | (Kb) |
| Intel Arria 10 GX | GX 160 | 440 | 8,800 | 1,680 | 1,050 | 9,850 |
| | GX 220 | 587 | 11,740 | 2,703 | 1,690 | 13,430 |
| | GX 270 | 750 | 15,000 | 3,922 | 2,452 | 17,452 |
| | GX 320 | 891 | 17,820 | 4,363 | 2,727 | 20,547 |
| | GX 480 | 1,431 | 28,620 | 6,662 | 4,164 | 32,784 |
| | GX 570 | 1,800 | 36,000 | 8,153 | 5,096 | 41,096 |
| | GX 660 | 2,131 | 42,620 | 9,260 | 5,788 | 48,408 |
| | GX 900 | 2,423 | 48,460 | 15,017 | 9,386 | 57,846 |
| | GX 1150 | 2,713 | 54,260 | 20,774 | 12,984 | 67,244 |
| Intel Arria 10 GT | GT 900 | 2,423 | 48,460 | 15,017 | 9,386 | 57,846 |
| | GT 1150 | 2,713 | 54,260 | 20,774 | 12,984 | 67,244 |
| Intel Arria 10 SX | SX 160 | 440 | 8,800 | 1,680 | 1,050 | 9,850 |
| | SX 220 | 587 | 11,740 | 2,703 | 1,690 | 13,430 |
| | SX 270 | 750 | 15,000 | 3,922 | 2,452 | 17,452 |
| | SX 320 | 891 | 17,820 | 4,363 | 2,727 | 20,547 |
| | SX 480 | 1,431 | 28,620 | 6,662 | 4,164 | 32,784 |
| | SX 570 | 1,800 | 36,000 | 8,153 | 5,096 | 41,096 |
| | SX 660 | 2,131 | 42,620 | 9,260 | 5,788 | 48,408 |

Table 18. Embedded Memory Capacity and Distribution in Intel Arria 10 Devices



Embedded Memory Configurations for Single-port Mode

Table 19. Single-port Embedded Memory Configurations for Intel Arria 10 Devices

This table lists the maximum configurations supported for single-port RAM and ROM modes.

| Memory Block | Depth (bits) | Programmable Width |
|--------------|--------------|--------------------|
| MLAB | 32 | x16, x18, or x20 |
| | 64 (10) | x8, x9, x10 |
| М20К | 512 | x40, x32 |
| | 1К | x20, x16 |
| | 2К | x10, x8 |
| | 4К | x5, x4 |
| | 8К | x2 |
| | 16K | ×1 |

Clock Networks and PLL Clock Sources

The clock network architecture is based on Intel's global, regional, and peripheral clock structure. This clock structure is supported by dedicated clock input pins, fractional clock synthesis PLLs, and integer I/O PLLs.

Clock Networks

The Intel Arria 10 core clock networks are capable of up to 800 MHz fabric operation across the full industrial temperature range. For the external memory interface, the clock network supports the hard memory controller with speeds up to 2,400 Mbps in a quarter-rate transfer.

To reduce power consumption, the Intel Quartus Prime software identifies all unused sections of the clock network and powers them down.

Fractional Synthesis and I/O PLLs

Intel Arria 10 devices contain up to 32 fractional synthesis PLLs and up to 16 I/O PLLs that are available for both specific and general purpose uses in the core:

- Fractional synthesis PLLs—located in the column adjacent to the transceiver blocks
- I/O PLLs—located in each bank of the 48 I/Os

Fractional Synthesis PLLs

You can use the fractional synthesis PLLs to:

- Reduce the number of oscillators that are required on your board
- Reduce the number of clock pins that are used in the device by synthesizing multiple clock frequencies from a single reference clock source

⁽¹⁰⁾ Supported through software emulation and consumes additional MLAB blocks.





Figure 6. Intel Arria 10 Transceiver Block Architecture

Transceiver Channels

All transceiver channels feature a dedicated Physical Medium Attachment (PMA) and a hardened Physical Coding Sublayer (PCS).

- The PMA provides primary interfacing capabilities to physical channels.
- The PCS typically handles encoding/decoding, word alignment, and other preprocessing functions before transferring data to the FPGA core fabric.

A transceiver channel consists of a PMA and a PCS block. Most transceiver banks have 6 channels. There are some transceiver banks that contain only 3 channels.

A wide variety of bonded and non-bonded data rate configurations is possible using a highly configurable clock distribution network. Up to 80 independent transceiver data rates can be configured.

The following figures are graphical representations of top views of the silicon die, which correspond to reverse views for flip chip packages. Different Intel Arria 10 devices may have different floorplans than the ones shown in the figures.



| Protocol | Data Rate (Gbps) | Transceiver IP | PCS Support |
|----------------------|----------------------------------|----------------|--------------|
| CPRI 6.0 (64B/66B) | 0.6144 to 10.1376 | Native PHY | Enhanced PCS |
| CPRI 4.2 (8B/10B) | 0.6144 to 9.8304 | Native PHY | Standard PCS |
| OBSAI RP3 v4.2 | 0.6144 to 6.144 | Native PHY | Standard PCS |
| SD-SDI/HD-SDI/3G-SDI | 0.143 ⁽¹²⁾ to 2.97 | Native PHY | Standard PCS |

Related Information

Intel Arria 10 Transceiver PHY User Guide

Provides more information about the supported transceiver protocols and PHY IP, the PMA architecture, and the standard, enhanced, and PCIe Gen3 PCS architecture.

SoC with Hard Processor System

Each SoC device combines an FPGA fabric and a hard processor system (HPS) in a single device. This combination delivers the flexibility of programmable logic with the power and cost savings of hard IP in these ways:

- Reduces board space, system power, and bill of materials cost by eliminating a discrete embedded processor
- Allows you to differentiate the end product in both hardware and software, and to support virtually any interface standard
- Extends the product life and revenue through in-field hardware and software updates

⁽¹²⁾ The 0.143 Gbps data rate is supported using oversampling of user logic that you must implement in the FPGA fabric.



Features of the HPS

The HPS has the following features:

- 1.2-GHz, dual-core ARM Cortex-A9 MPCore processor with up to 1.5-GHz via overdrive
 - ARMv7-A architecture that runs 32-bit ARM instructions, 16-bit and 32-bit Thumb instructions, and 8-bit Java byte codes in Jazelle style
 - Superscalar, variable length, out-of-order pipeline with dynamic branch prediction
 - Instruction Efficiency 2.5 MIPS/MHz, which provides total performance of 7500 MIPS at 1.5 GHz
- Each processor core includes:
 - 32 KB of L1 instruction cache, 32 KB of L1 data cache
 - Single- and double-precision floating-point unit and NEON media engine
 - CoreSight debug and trace technology
 - Snoop Control Unit (SCU) and Acceleration Coherency Port (ACP)
- 512 KB of shared L2 cache
- 256 KB of scratch RAM
- Hard memory controller with support for DDR3, DDR4 and optional error correction code (ECC) support
- Multiport Front End (MPFE) Scheduler interface to the hard memory controller
- 8-channel direct memory access (DMA) controller
- QSPI flash controller with SIO, DIO, QIO SPI Flash support
- NAND flash controller (ONFI 1.0 or later) with DMA and ECC support, updated to support 8 and 16-bit Flash devices and new command DMA to offload CPU for fast power down recovery
- Updated SD/SDIO/MMC controller to eMMC 4.5 with DMA with CE-ATA digital command support
- 3 10/100/1000 Ethernet media access control (MAC) with DMA
- 2 USB On-the-Go (OTG) controllers with DMA
- 5 I²C controllers (3 can be used by EMAC for MIO to external PHY)
- 2 UART 16550 Compatible controllers
- 4 serial peripheral interfaces (SPI) (2 Master, 2 Slaves)
- 62 programmable general-purpose I/Os, which includes 48 direct share I/Os that allows the HPS peripherals to connect directly to the FPGA I/Os
- 7 general-purpose timers
- 4 watchdog timers
- Anti-tamper, Secure Boot, Encryption (AES) and Authentication (SHA)



System Peripherals and Debug Access Port

Each Ethernet MAC, USB OTG, NAND flash controller, and SD/MMC controller module has an integrated DMA controller. For modules without an integrated DMA controller, an additional DMA controller module provides up to eight channels of high-bandwidth data transfers. Peripherals that communicate off-chip are multiplexed with other peripherals at the HPS pin level. This allows you to choose which peripherals interface with other devices on your PCB.

The debug access port provides interfaces to industry standard JTAG debug probes and supports ARM CoreSight debug and core traces to facilitate software development.

HPS-FPGA AXI Bridges

The HPS–FPGA bridges, which support the Advanced Microcontroller Bus Architecture (AMBA) Advanced eXtensible Interface (AXI^m) specifications, consist of the following bridges:

- FPGA-to-HPS AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the FPGA fabric to issue transactions to slaves in the HPS.
- HPS-to-FPGA Avalon/AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the HPS to issue transactions to slaves in the FPGA fabric.
- Lightweight HPS-to-FPGA AXI bridge—a lower latency 32 bit width bus that allows the HPS to issue transactions to soft peripherals in the FPGA fabric. This bridge is primarily used for control and status register (CSR) accesses to peripherals in the FPGA fabric.

The HPS–FPGA AXI bridges allow masters in the FPGA fabric to communicate with slaves in the HPS logic, and vice versa. For example, the HPS-to-FPGA AXI bridge allows you to share memories instantiated in the FPGA fabric with one or both microprocessors in the HPS, while the FPGA-to-HPS AXI bridge allows logic in the FPGA fabric to access the memory and peripherals in the HPS.

Each HPS–FPGA bridge also provides asynchronous clock crossing for data transferred between the FPGA fabric and the HPS.

HPS SDRAM Controller Subsystem

The HPS SDRAM controller subsystem contains a multiport SDRAM controller and DDR PHY that are shared between the FPGA fabric (through the FPGA-to-HPS SDRAM interface), the level 2 (L2) cache, and the level 3 (L3) system interconnect. The FPGA-to-HPS SDRAM interface supports AMBA AXI and Avalon[®] Memory-Mapped (Avalon-MM) interface standards, and provides up to six individual ports for access by masters implemented in the FPGA fabric.

The HPS SDRAM controller supports up to 3 masters (command ports), 3x 64-bit read data ports and 3x 64-bit write data ports.

To maximize memory performance, the SDRAM controller subsystem supports command and data reordering, deficit round-robin arbitration with aging, and high-priority bypass features.



The optional power reduction techniques in Intel Arria 10 devices include:

- SmartVID—a code is programmed into each device during manufacturing that allows a smart regulator to operate the device at lower core V_{CC} while maintaining performance
- **Programmable Power Technology**—non-critical timing paths are identified by the Intel Quartus Prime software and the logic in these paths is biased for low power instead of high performance
- Low Static Power Options—devices are available with either standard static power or low static power while maintaining performance

Furthermore, Intel Arria 10 devices feature Intel's industry-leading low power transceivers and include a number of hard IP blocks that not only reduce logic resources but also deliver substantial power savings compared to soft implementations. In general, hard IP blocks consume up to 90% less power than the equivalent soft logic implementations.

Incremental Compilation

The Intel Quartus Prime software incremental compilation feature reduces compilation time and helps preserve performance to ease timing closure. The incremental compilation feature enables the partial reconfiguration flow for Intel Arria 10 devices.

Incremental compilation supports top-down, bottom-up, and team-based design flows. This feature facilitates modular, hierarchical, and team-based design flows where different designers compile their respective design sections in parallel. Furthermore, different designers or IP providers can develop and optimize different blocks of the design independently. These blocks can then be imported into the top level project.

Document Revision History for Intel Arria 10 Device Overview

| Document Version | Changes |
|---------------------|--|
| 2018.04.09 | Updated the lowest V_{CC} from 0.83 V to 0.82 V in the topic listing a summary of the device features. |

| Date | Version | Changes |
|--------------|------------|--|
| January 2018 | 2018.01.17 | • Updated the maximum data rate for HPS (Intel Arria 10 SX devices external memory interface DDR3 controller from 2,166 Mbps to 2,133 Mbps. |
| | | Updated maximum frequency supported for half rate QDRII and QDRII + SRAM to 633 MHz in <i>Memory Standards Supported by the Soft</i> <i>Memory Controller</i> table. |
| | | Updated transceiver backplane capability to 12.5 Gbps. |
| | | • Removed transceiver speed grade 5 in <i>Sample Ordering Core and Available Options for Intel Arria 10 GX Devices</i> figure. |
| | 1 | continued |

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| September 2017 July 2017 July 2017 May 2017 May 2017 | 2017.09.20 2017.07.13 2017.07.06 2017.05.08 | Removed package code 40, low static power, SmartVID, industrial, and military operating temperature support from <i>Sample Ordering Core and Available Options for Intel Arria 10 GT Devices</i> figure. Updated short reach transceiver rate for Intel Arria 10 GT devices to 25.8 Gbps. Removed On-Die Instrumentation — EyeQ and Jitter Margin Tool support from <i>PMA Features of the Transceivers in Intel Arria 10 Devices</i> table. Updated the maximum speed of the DDR4 external memory interface from 1,333 MHz/2,666 Mbps to 1,200 MHz/2,400 Mbps. Corrected the automotive temperature range in the figure showing the available options for the Intel Arria 10 GX devices from "-40°C to 125°C". Added automotive temperature option to Intel Arria 10 GX device family. Corrected protocol names with "1588" to "IEEE 1588v2". Updated the vertical migration table to remove vertical migration between Intel Arria 10 GX and Intel Arria 10 SX device variants. |
|--|--|--|
| July 2017 July 2017 May 2017 | 2017.07.13 2017.07.06 | 1,333 MHz/2,666 Mbps to 1,200 MHz/2,400 Mbps. Corrected the automotive temperature range in the figure showing the available options for the Intel Arria 10 GX devices from "-40°C to 100°C" to "-40°C to 125°C". Added automotive temperature option to Intel Arria 10 GX device family. Corrected protocol names with "1588" to "IEEE 1588v2". Updated the vertical migration table to remove vertical migration |
| July 2017 May 2017 | 2017.07.06 | available options for the Intel Arria 10 GX devices from "-40°C to 100°C" to "-40°C to 125°C". Added automotive temperature option to Intel Arria 10 GX device family. Corrected protocol names with "1588" to "IEEE 1588v2". Updated the vertical migration table to remove vertical migration |
| May 2017 | | Corrected protocol names with "1588" to "IEEE 1588v2". Updated the vertical migration table to remove vertical migration |
| | 2017.05.08 | Updated the vertical migration table to remove vertical migration |
| March 2017 | | Removed all "Preliminary" marks. |
| | 2017.03.15 | Removed the topic about migration from Intel Arria 10 to Intel Stratix 10 devices. Rebranded as Intel. |
| October 2016 | 2016.10.31 | Removed package F36 from Intel Arria 10 GX devices. Updated Intel Arria 10 GT sample ordering code and maximum GX transceiver count. Intel Arria 10 GT devices are available only in the SF45 package option with a maximum of 72 transceivers. |
| May 2016 | 2016.05.02 | Updated the FPGA Configuration and HPS Booting topic. Remove V_{CC} PowerManager from the Summary of Features, Power Management and Arria 10 Device Variants and packages topics. This feature is no longer supported in Arria 10 devices. Removed LPDDR3 from the Memory Standards Supported by the HPS Hard Memory Controller table in the Memory Standards Supported by Intel Arria 10 Devices topic. This standard is only supported by the FPGA. Removed transceiver speed grade 5 from the Device Variants and Packages topic for Arria 10 GX and SX devices. |
| February 2016 | 2016.02.11 | Changed the maximum Arria 10 GT datarate to 25.8 Gbps and the minimum datarate to 1 Gbps globally. Revised the state for Core clock networks in the Summary of Features topic. Changed the transceiver parameters in the "Summary of Features for Arria 10 Devices" table. Changed the transceiver parameters in the "Maximum Resource Counts for Arria 10 GT Devices" table. Changed the package availability for GT devices in the "Package Plan for Arria 10 GT Devices" table. Changed the package configurations for GT devices in the "Migration Capability Across Arria 10 Product Lines" figure. Changed the transceiver descriptions in the "Device Variants for the Arria 10 Device Family" table. Changed the "Sample Ordering Code and Available Options for Arria 10 GT Devices" figure. Changed the datarates for GT devices in the "PMA Features" section. Changed the datarates for GT devices in the "PCS Features" section. |

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| Date | Version | Changes |
|---------------|------------|--|
| August 2014 | 2014.08.18 | Updated Memory (Kb) M20K maximum resources for Arria 10 GX 660 devices from 42,660 to 42,620. |
| | | Added GPIO columns consisting of LVDS I/O Bank and 3V I/O Bank in the Package Plan table. |
| | | • Added how to use memory interface clock frequency higher than 533 MHz in the I/O vertical migration. |
| | | Added information to clarify that RLDRAM3 support uses hard PHY with soft memory controller. |
| | | Added variable precision DSP blocks support for floating-point arithmetic. |
| June 2014 | 2014.06.19 | Updated number of dedicated I/Os in the HPS block to 17. |
| February 2014 | 2014.02.21 | Updated transceiver speed grade options for GT devices in Figure 2. |
| February 2014 | 2014.02.06 | Updated data rate for Arria 10 GT devices from 28.1 Gbps to 28.3 Gbps. |
| December 2013 | 2013.12.10 | Updated the HPS memory standards support from LPDDR2 to LPDDR3. Updated HPS block diagram to include dedicated HPS I/O and FPGA Configuration blocks as well as repositioned SD/SDIO/MMC, DMA, SPI and NAND Flash with ECC blocks . |
| December 2013 | 2013.12.02 | Initial release. |